

# HAT1004F

## Silicon P Channel Power MOS FET

### Application

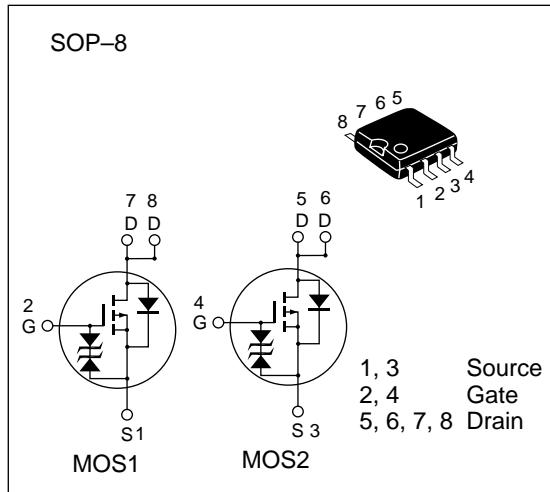
Power switching

### Features

- Low on-resistance
- Capable of 2.5V gate drive
- Low drive current
- High density mounting

### Ordering Information

Hitachi Code	FP-8D
EIAJ Code	SC-527-8A
JEDEC Code	—



**Table 1 Absolute Maximum Ratings (Ta = 25°C)**

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	-20	V
Gate to source voltage	V <sub>GSS</sub>	±10	V
Drain current	I <sub>D</sub>	-2.5	A
Drain peak current	I <sub>D(pulse)*</sub>	-10	A
Channel dissipation	P <sub>ch***</sub>	1.5	W
Channel dissipation	P <sub>ch**</sub>	1	W
Channel temperature	T <sub>ch</sub>	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

\* PW ≤ 10 µs, duty cycle ≤ 1 %

\*\* 1 Drive operation When using the glass epoxy board (40 x 40 x 1.6 mm)

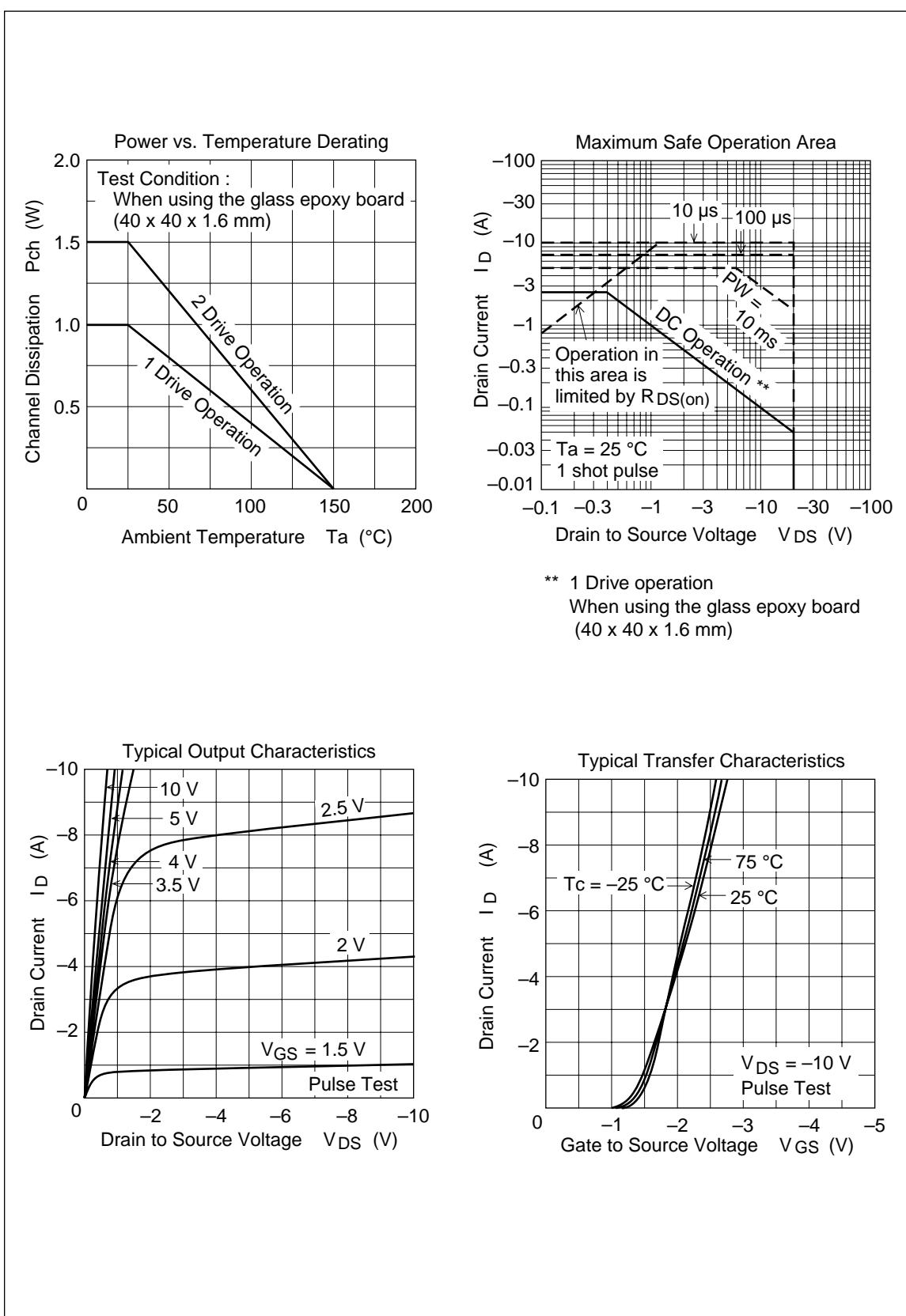
\*\*\* 2 Drive operation When using the glass epoxy board (40 x 40 x 1.6 mm)

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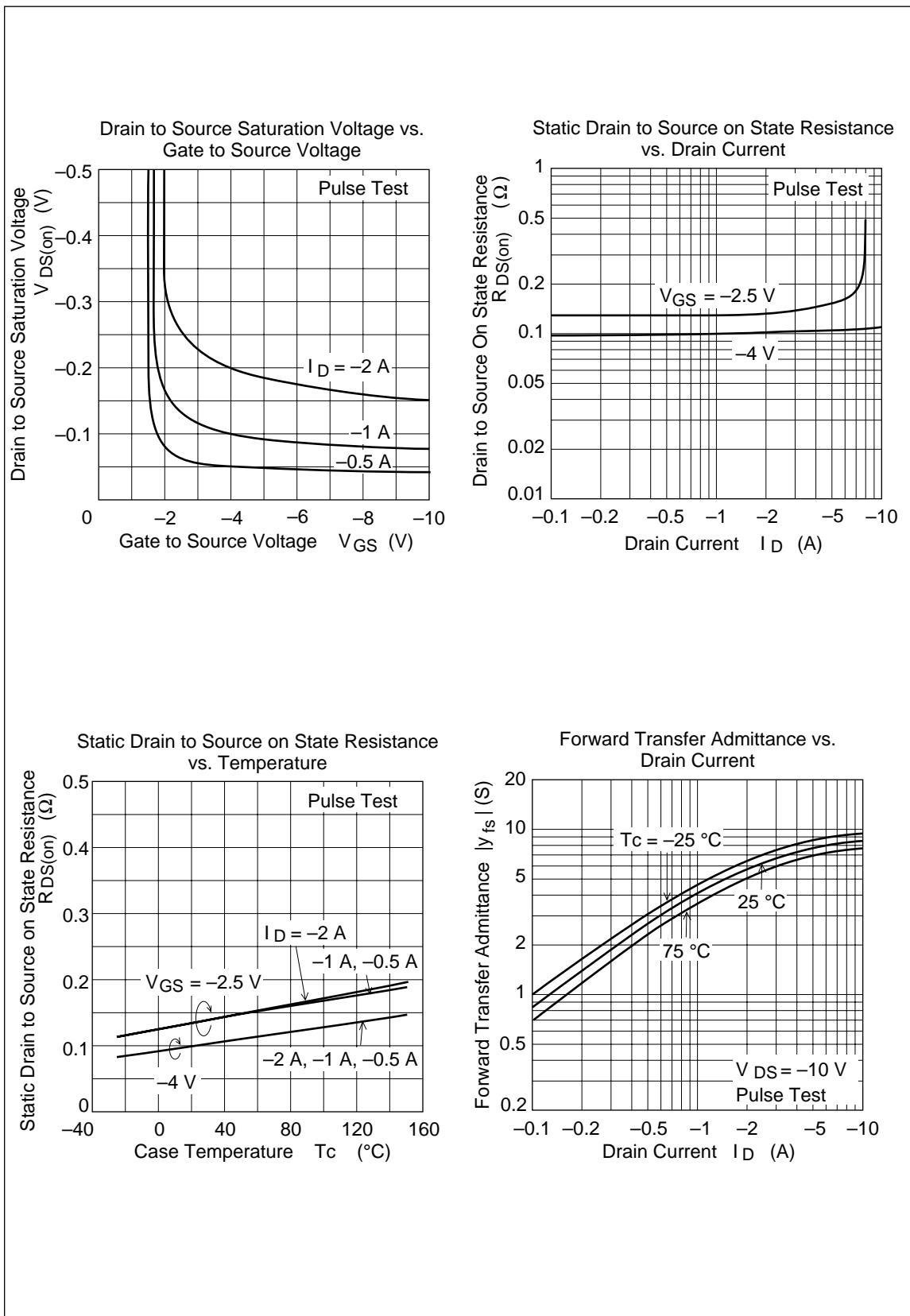
**Table 2 Electrical Characteristics (Ta = 25°C)**

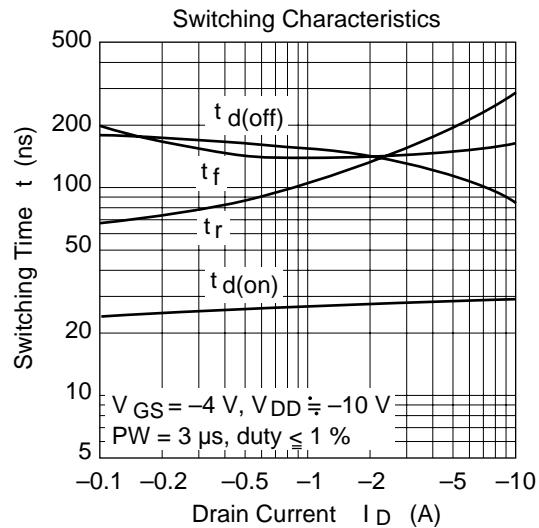
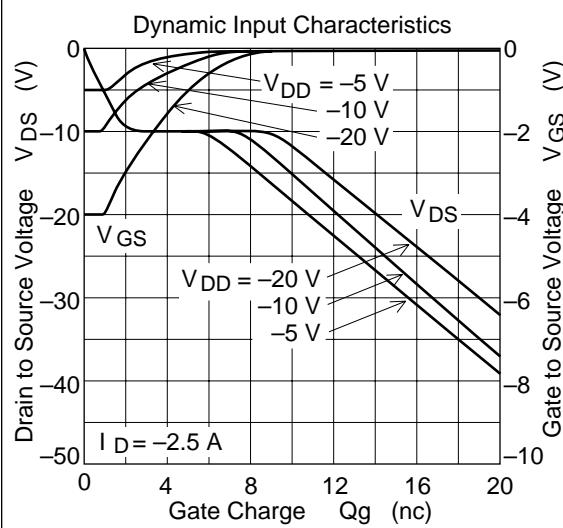
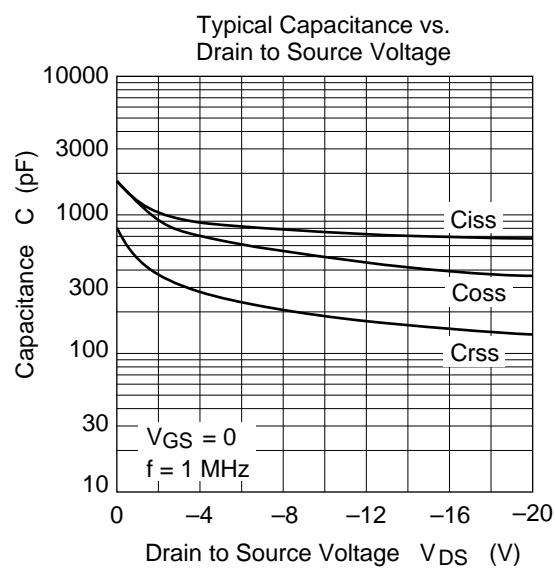
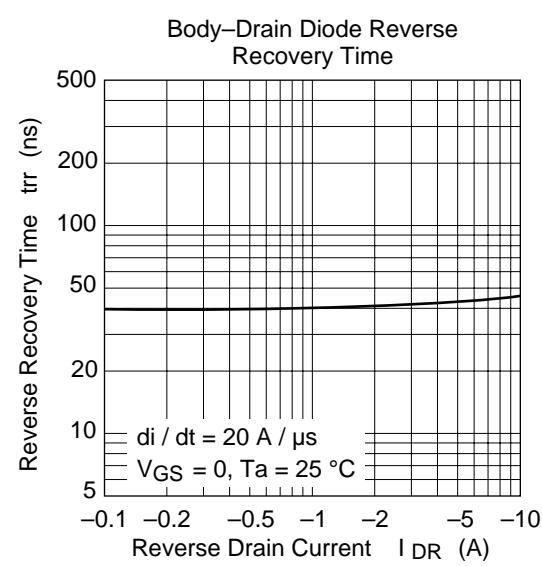
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	-20	—	—	V	I <sub>D</sub> = -10 mA, V <sub>GS</sub> = 0
Gate to source breakdown voltage	V <sub>(BR)GSS</sub>	±10	—	—	V	I <sub>G</sub> = ±200 µA, V <sub>DS</sub> = 0
Gate to source leak current	I <sub>GSS</sub>	—	—	±10	µA	V <sub>GS</sub> = ±6.5 V, V <sub>DS</sub> = 0
Zero gate voltage drain current	I <sub>DSS</sub>	—	—	-10	µA	V <sub>DS</sub> = -20 V, V <sub>GS</sub> = 0
Gate to source cutoff voltage	V <sub>GS(off)</sub>	-0.5	—	-1.5	V	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -1 mA
Static drain to source on state resistance	R <sub>DS(on)</sub>	—	0.1	0.12	Ω	I <sub>D</sub> = -2 A V <sub>GS</sub> = -4 V *
		—	0.14	0.2	Ω	I <sub>D</sub> = -2 A V <sub>GS</sub> = -2.5 V *
Forward transfer admittance	y <sub>fs</sub>	3.5	5.5	—	S	I <sub>D</sub> = -2 A V <sub>DS</sub> = -10 V *
Input capacitance	C <sub>iss</sub>	—	750	—	pF	V <sub>DS</sub> = -10 V
Output capacitance	C <sub>oss</sub>	—	500	—	pF	V <sub>GS</sub> = 0
Reverse transfer capacitance	C <sub>rss</sub>	—	190	—	pF	f = 1 MHz
Turn-on delay time	t <sub>d(on)</sub>	—	28	—	ns	V <sub>GS</sub> = -4 V, I <sub>D</sub> = -2 A
Rise time	t <sub>r</sub>	—	125	—	ns	V <sub>DD</sub> = -10 V
Turn-off delay time	t <sub>d(off)</sub>	—	135	—	ns	
Fall time	t <sub>f</sub>	—	135	—	ns	
Body-drain diode forward voltage	V <sub>DF</sub>	—	-0.9	—	V	I <sub>F</sub> = -2.5 A, V <sub>GS</sub> = 0
Body-drain diode reverse recovery time	trr	—	40	—	ns	I <sub>F</sub> = -2.5 A, V <sub>GS</sub> = 0 diF / dt = 20A / µs

\* Pulse Test

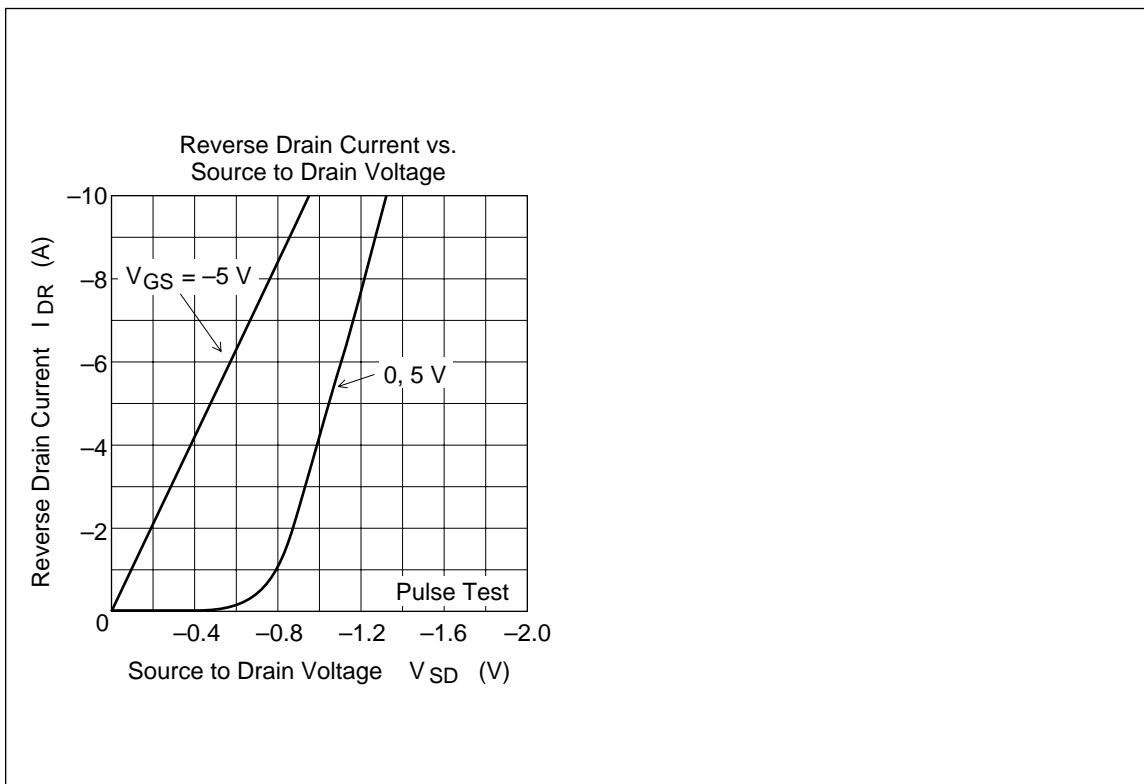


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**Package Dimensions**

Unit : mm

